



General Description

It combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. It combines one N Channel MOSFET and one P channel MOSFET.

Product Summary

Features

Trench technology
 $R_{DS(ON)}$ to minimize conductive loss

Dual DIE in one package

Application

Power Management in Notebook Computer
BLDC Motor driver

Ordering Information:

ZMC88102S

N Channel Absolute Maximum Ratings $T_c = 25$

Symbol	Rating	Unit
V_{DS}	100	V
V_{GS}	± 20	V
I_D	4.0	A
I_{DM}	12	A
$P_D @ TC=25^\circ C$	3.4	W
$P_D @ TA=25^\circ C$	0.69	W
T_J	-55 to 150	$^\circ C$
T_{STG}	-55 to 150	$^\circ C$



Reverse transfer capacitance	Crss		-	51	-	
------------------------------	------	--	---	----	---	--

Gate Charge characteristics(T_a = 25)

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Qg	V _{DD} =25V	-	22.4	-	nC
Gate - Source charge	Qgs	I _D =4A	-	4.5	-	
Gate - Drain charge	Qgd	V _{GS} = 10V	-	3.4	-	

P Channel Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-100			V
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =-250uA	-1.0		-2.5	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-100V, V _{GS} =0V			-1.0	uA
Gate- Source Leakage Current	I _{GSS}	V _{GS} =±20V ,V _{DS} =0V			±100	nA
Static Drain-source On Resistance		V _{GS} =-10V, I _D =-2A		170	221	mΩ
		V _{GS} =-4.5V, I _D =-2A		185	240	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-10V, I _D =-2A		16		s
Source-drain voltage	V _{SD}	I _S =-2A			1.28	V

Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
-----------	--------	-----------	------	-----	------	------

N Channel characteristics curve

Fig.1 Power Dissipation Derating Curve

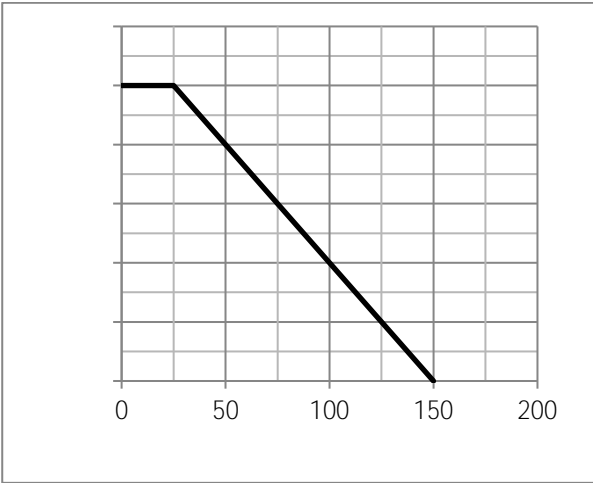


Fig.2 Typical output Characteristics

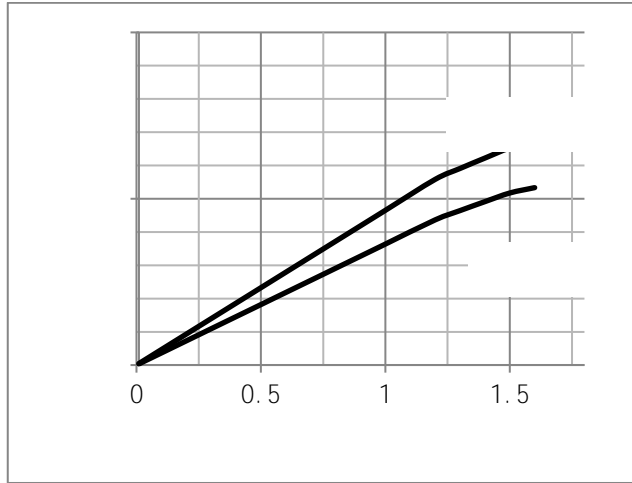


Fig.3 Threshold Voltage V.S Junction Temperature

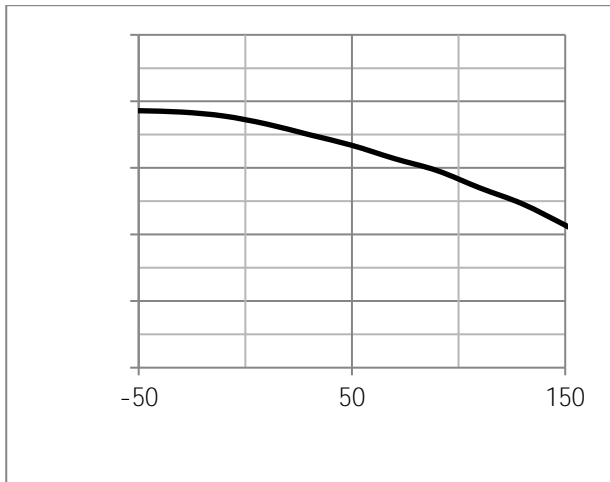
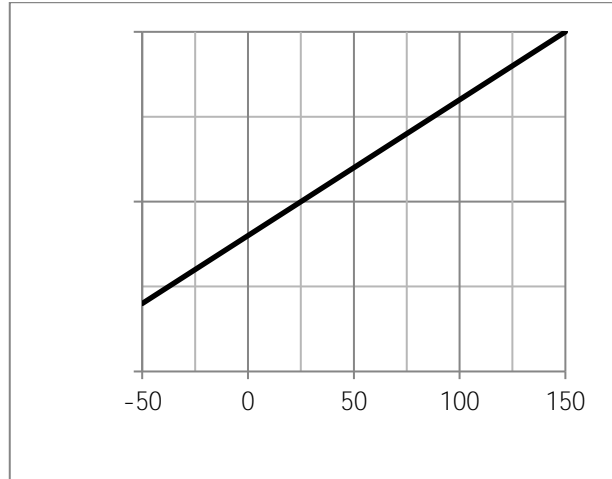
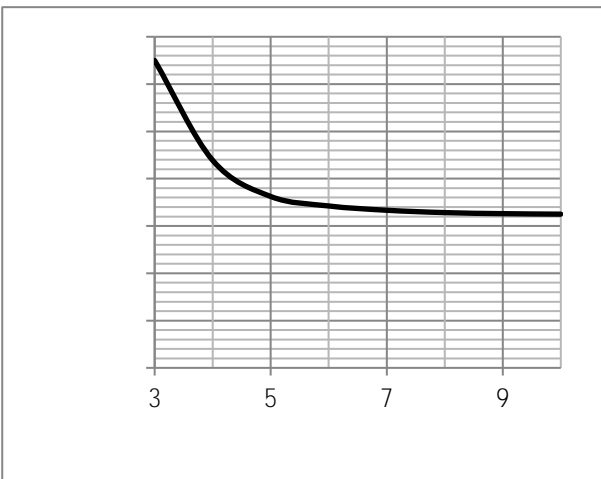
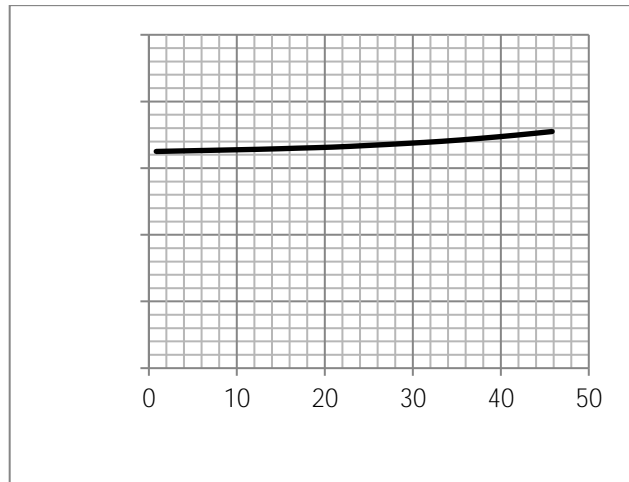


Fig.4 Resistance V.S Drain Current





Test Circuit

Fig.1 Switching Time Measurement Circuit

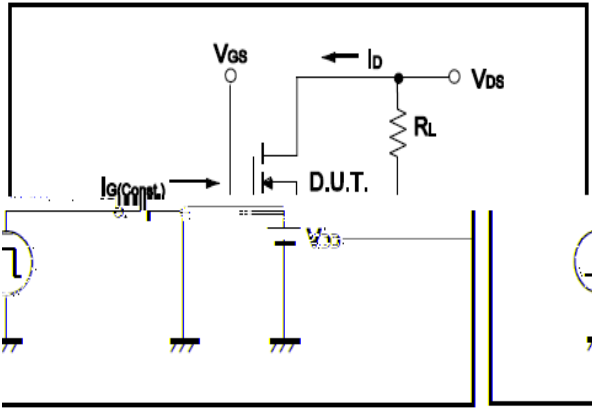


Fig.2 Gate Charge Waveform

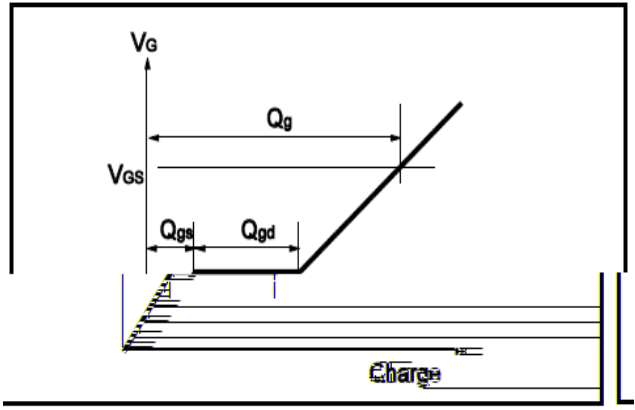


Fig.3 Switching Time Measurement Circuit

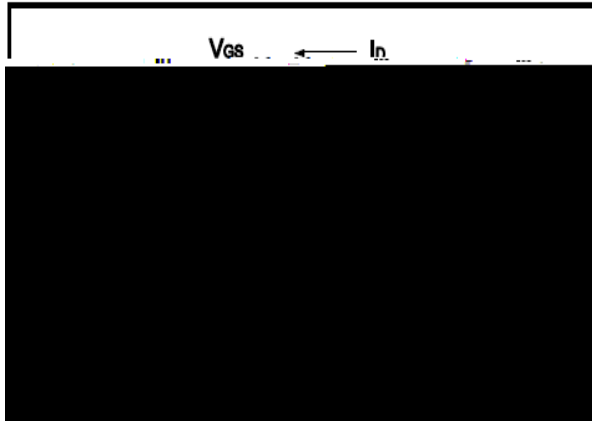


Fig.4 Gate Charge Waveform

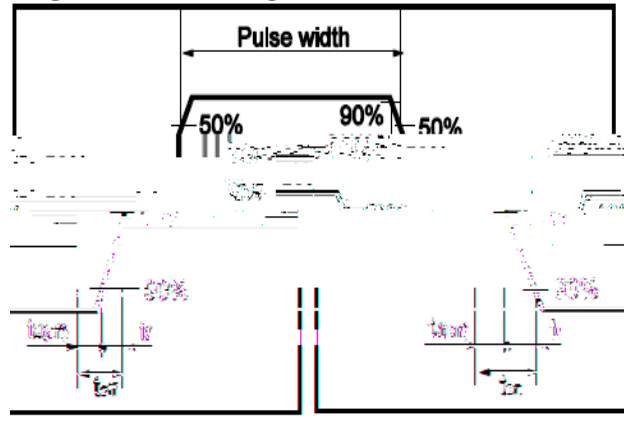


Fig.5 Avalanche Measurement Circuit

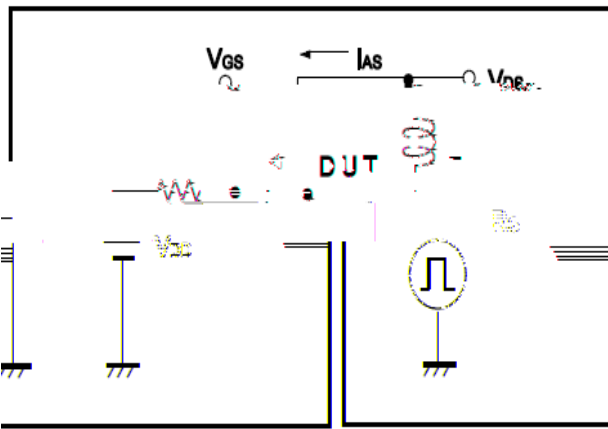
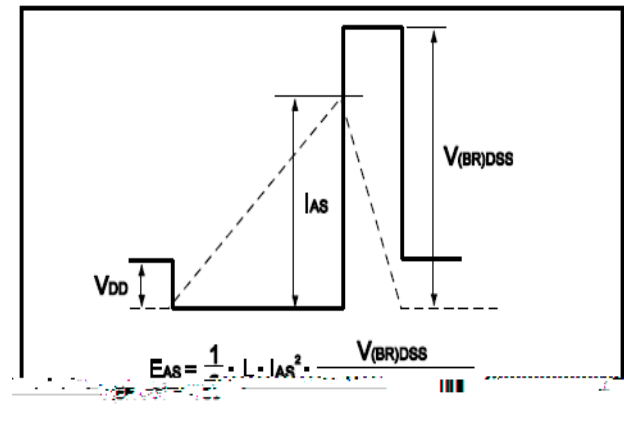


Fig.6 Avalanche Waveform



Dimensions(SOP8)

Unit: mm

SYMBOL	min	TYP	max	SYMBOL	min		max
A	4.80		5.25	C	1.30		1.75
A1	0.37		0.49	C1	0.55		0.75
A2		1.27		C2	0.55		0.65
A3		0.41		C3	0.05		0.20
B	5.80		6.20	C4	0.10	0.20	0.23
B1	3.80		4.10	D		1.05	
B2		5.00		D1	0.40		0.62

